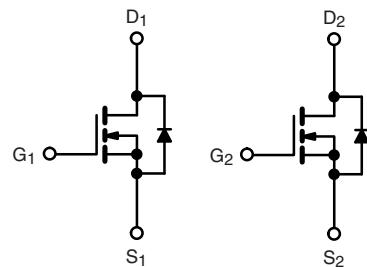


Features

- TrenchFET® power MOSFET
- 100 % R_g and UIS tested

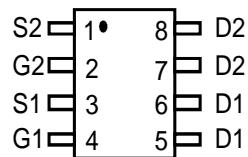


N-Channel MOSFET N-Channel MOSFET

Product Summary

V_{DS}	60V
I_D (at $V_{GS}=10V$)	7A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 19mΩ
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	< 23mΩ

Top View



ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current	$T_C = 25\text{ °C}$	I_D	7	
	$T_C = 125\text{ °C}$		4	
Continuous Source Current (Diode Conduction) ^a		I_S	3.6	A
Pulsed Drain Current ^b		I_{DM}	28	
Single Pulse Avalanche Current	$L = 0.1\text{ mH}$	I_{AS}	18	mJ
Single Pulse Avalanche Energy		E_{AS}	16.2	
Maximum Power Dissipation ^b	$T_C = 25\text{ °C}$	P_D	4	W
	$T_C = 125\text{ °C}$		1.3	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to +175	°C

THERMAL RESISTANCE RATING **S**

PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	110	°C/W
Junction-to-Foot (Drain)		R_{thJF}	34	

Notes

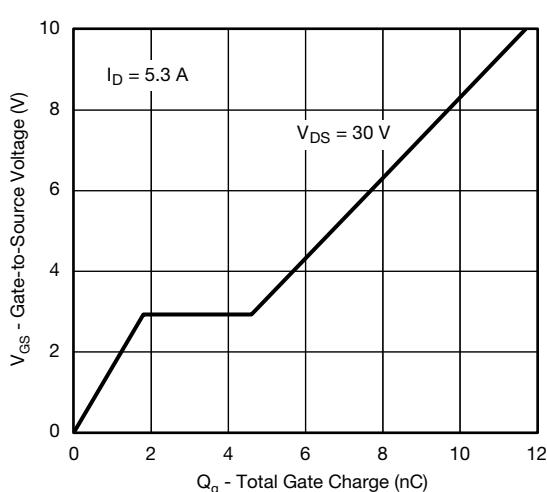
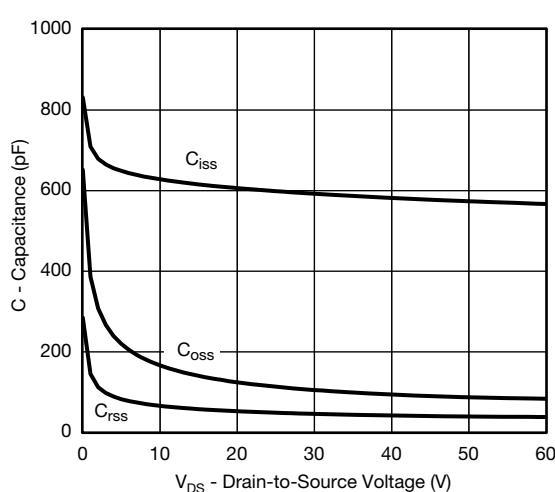
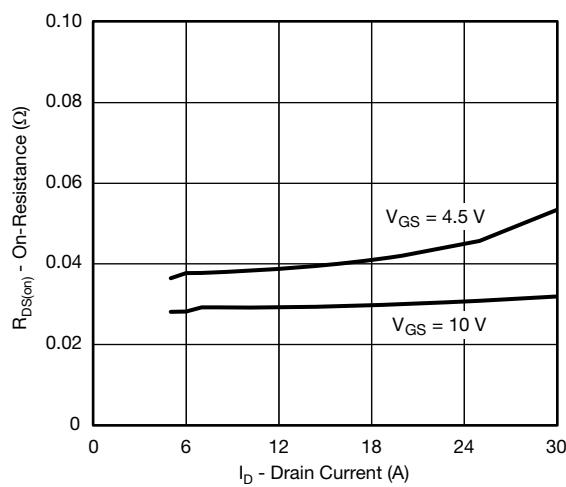
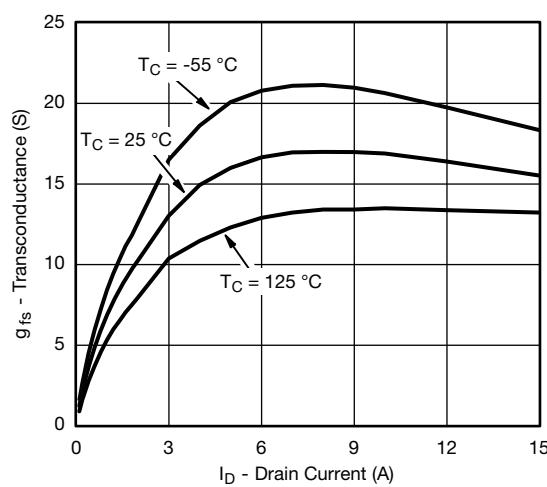
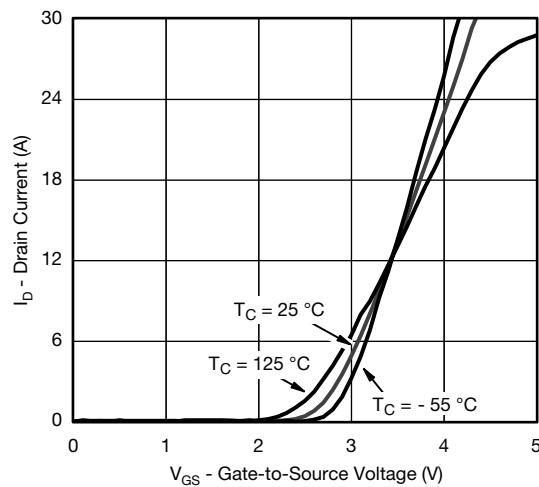
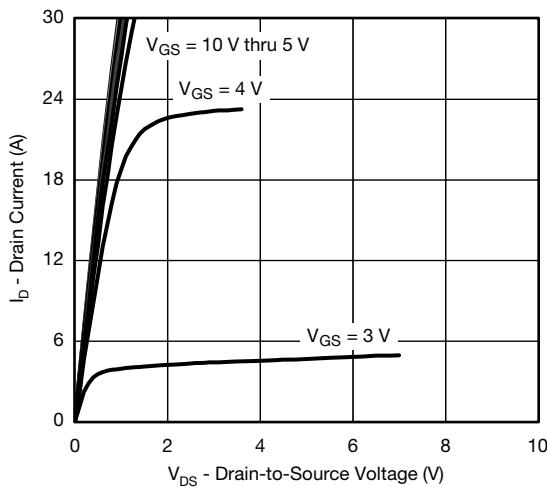
- a. Package limited.
- b. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
- c. When mounted on 1" square PCB (FR4 material).

SPECIFICATIONS ($T_C = 25^\circ\text{C}$, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$		60	-	-	V	
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$		1.5	2.0	2.5		
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}$, $V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{GS} = 0 \text{ V}$	$V_{DS} = 60 \text{ V}$	-	-	1	μA	
		$V_{GS} = 0 \text{ V}$	$V_{DS} = 60 \text{ V}$, $T_J = 125^\circ\text{C}$	-	-	50		
		$V_{GS} = 0 \text{ V}$	$V_{DS} = 60 \text{ V}$, $T_J = 175^\circ\text{C}$	-	-	150		
On-State Drain Current ^a	$I_{D(\text{on})}$	$V_{GS} = 10 \text{ V}$	$V_{DS} \geq 5 \text{ V}$	20	-	-	A	
Drain-Source On-State Resistance ^a	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}$	$I_D = 4.5 \text{ A}$ -		19	21	$\text{m}\Omega$	
		$V_{GS} = 4.5 \text{ V}$	$I_D = 4 \text{ A}$ -		23	25		
Forward Transconductance ^f	g_{fs}	$V_{DS} = 15 \text{ V}$, $I_D = 4.5 \text{ A}$		-	15	-	S	
Dynamic ^b								
Input Capacitance	C_{iss}	$V_{GS} = 0 \text{ V}$	$V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	-	600	750	pF	
Output Capacitance	C_{oss}			-	110	140		
Reverse Transfer Capacitance	C_{rss}			-	50	62		
Total Gate Charge ^c	Q_g	$V_{GS} = 10 \text{ V}$	$V_{DS} = 30 \text{ V}$, $I_D = 5.3 \text{ A}$	-	11.7	18	nC	
Gate-Source Charge ^c	Q_{gs}			-	1.8	2.7		
Gate-Drain Charge ^c	Q_{gd}			-	2.8	4.2		
Gate Resistance	R_g	$f = 1 \text{ MHz}$		1.3	-	6	Ω	
Turn-On Delay Time ^c	$t_{d(\text{on})}$	$V_{DD} = 30 \text{ V}$, $R_L = 6.8 \Omega$ $I_D \leq 4.4 \text{ A}$, $V_{GEN} = 10 \text{ V}$, $R_g = 1 \Omega$		-	7	11	ns	
Rise Time ^c	t_r			-	3.3	5		
Turn-Off Delay Time ^c	$t_{d(\text{off})}$			-	22.4	33.5		
Fall Time ^c	t_f			-	2.1	3.2		
Source-Drain Diode Ratings and Characteristics ^b								
Pulsed Current ^a	I_{SM}			-	-	28	A	
Forward Voltage	V_{SD}	$I_F = 2 \text{ A}$, $V_{GS} = 0 \text{ V}$		-	0.75	1.1	V	

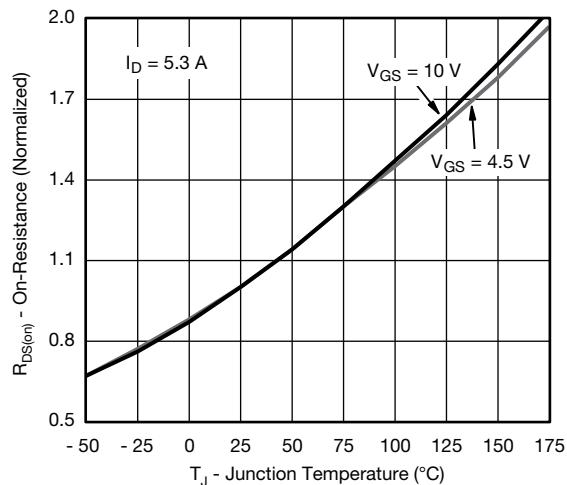
Notes

- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2 \%$.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

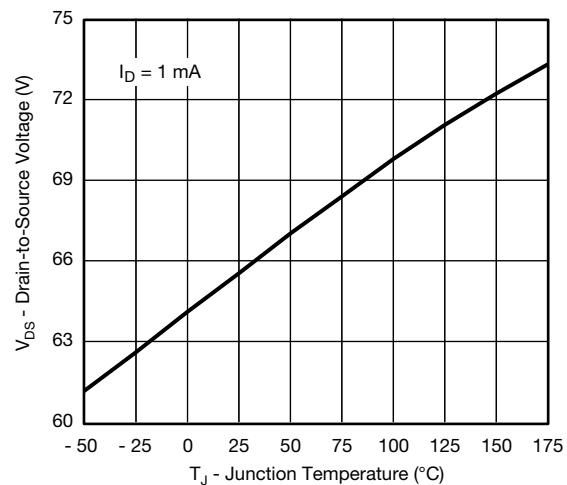
TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)



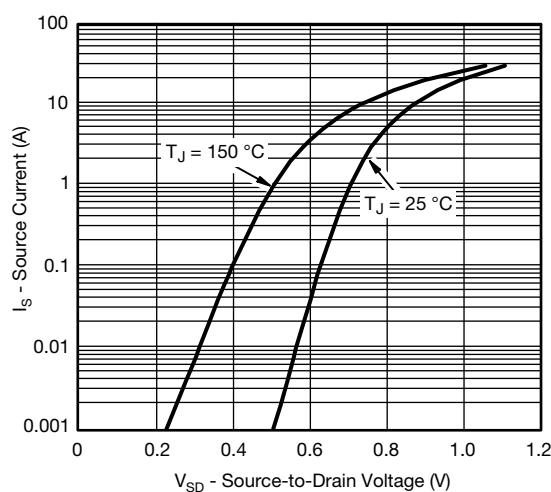
TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)



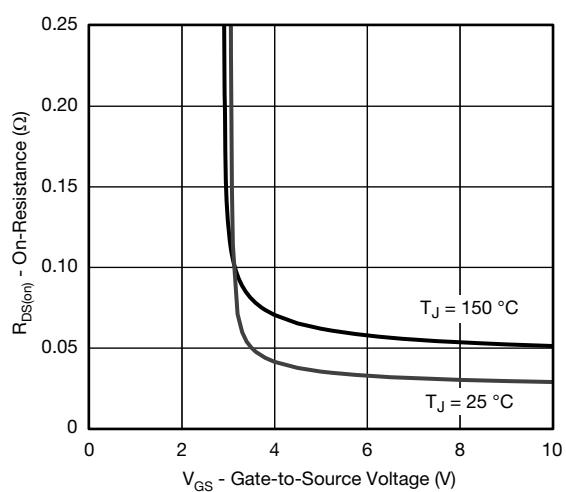
On-Resistance vs. Junction Temperature



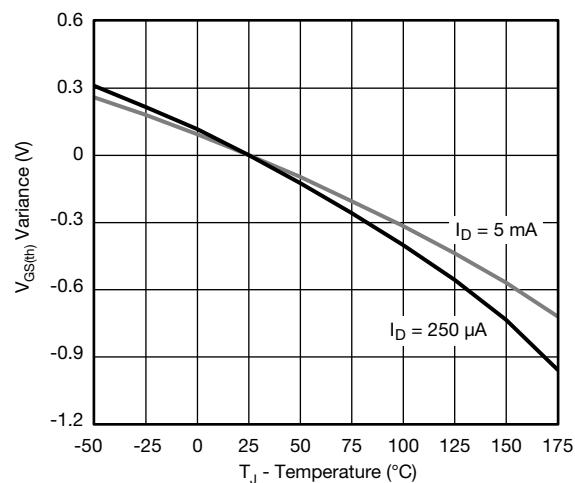
Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage

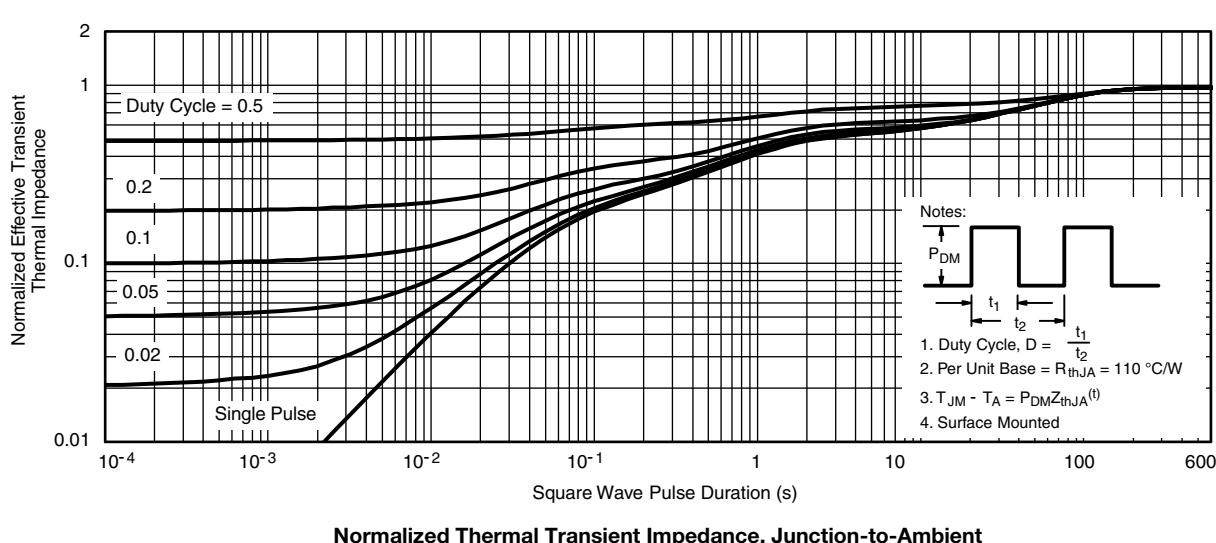
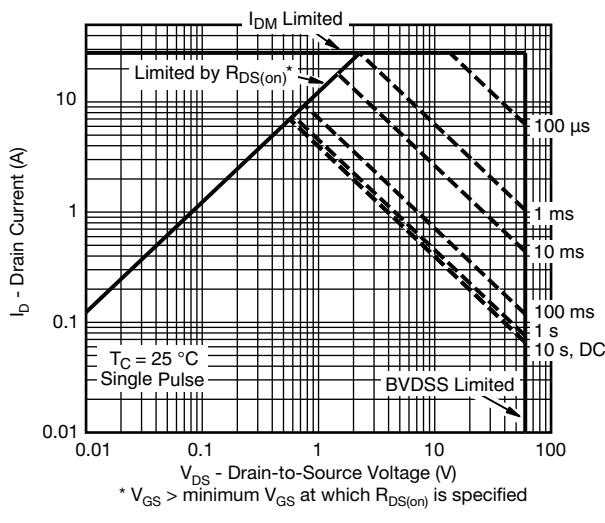


On-Resistance vs. Gate-to-Source Voltage

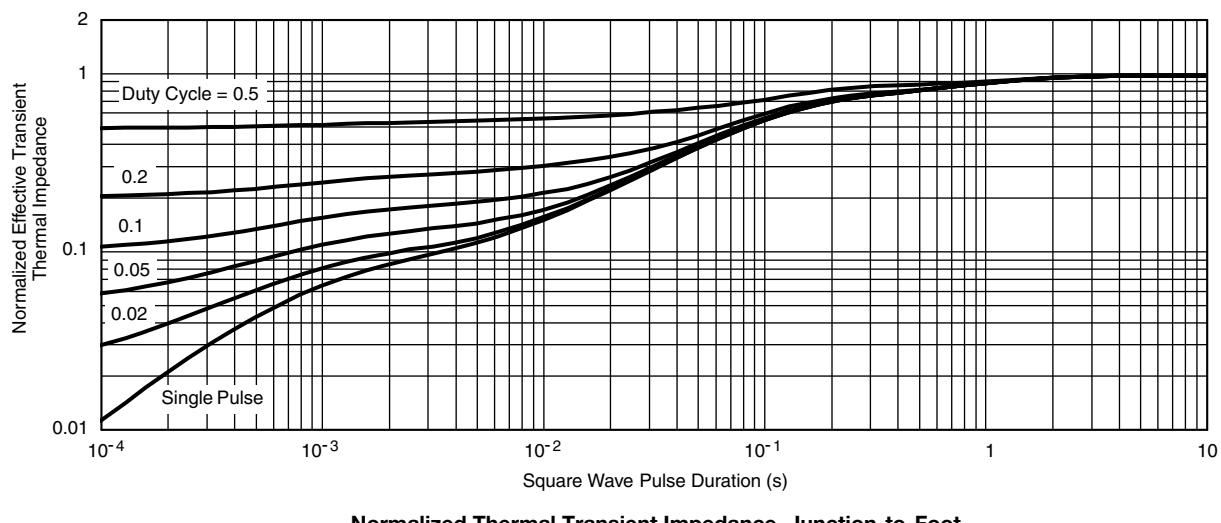


Threshold Voltage

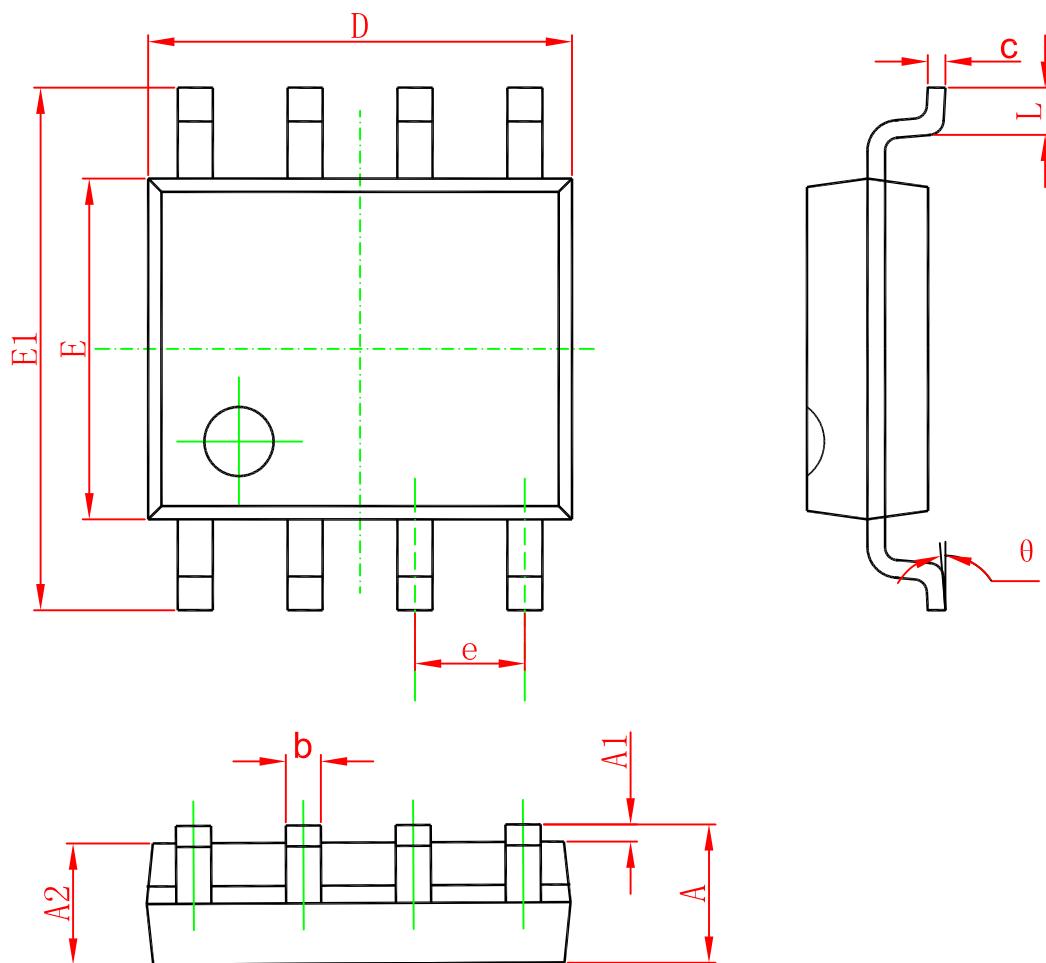
THERMAL RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise noted)



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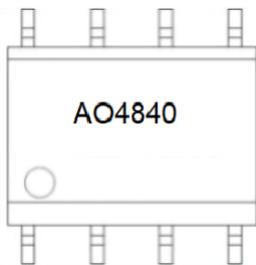


SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

Marking



Ordering information

Order code	Package	Baseqty	Deliverymode
AO4840	SOP-8	3000	Tape and reel